

## 650V GaN HEMT

### Description

The CC65H270TOEI Series 650V, 270mΩ gallium nitride (GaN) FETs are normally-off devices.

Classicchip GaN FETs offer better efficiency through lower gate charge, faster switching speeds, and lower dynamic onresistance, delivering significant advantages over traditional silicon (Si) devices.

Classicchip is a leading-edge wide band gap supplier with world-class innovation .

### Automotive

- Adapter
- Renewable energy
- Telecom and data-com
- Servo motors
- Industrial
- Automotive

### General Features

Easy to drive—compatible with standard gate drivers

Low conduction and switching losses

RoHS compliant and Halogen-free

### Benefits

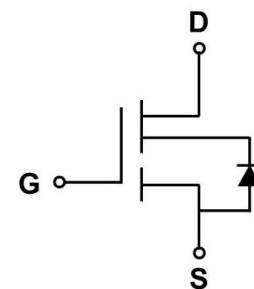
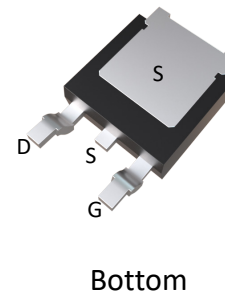
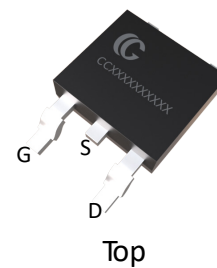
Increased efficiency through fast switching

Increased power density

Reduced system size and weight

### Ordering Information

Part Number	Package	Package Configuration
CC65H270TOEI	TO252	Source



Circuit Symbol

### Features

$BV_{DSS}$	$R_{DS(ON)}$	$I_{DS}$	$Q_G$
650V	270mΩ	7.9A	7.9nC

## Absolute Maximum Ratings

$T_c=25^\circ\text{C}$  unless otherwise stated

Symbol	Parameter	Limit value	Unit	
$V_{DSS}$	Drain to source voltage ( $T_J = -55^\circ\text{C}$ to $150^\circ\text{C}$ )	650		
$V_{(TR)DSS}$	Drain to source voltage-transient <sup>a</sup>	800	V	
$V_{GSS}$	Gate to source voltage	-20~+20		
$I_D$	Continuous drain current @ $T_c=25^\circ\text{C}$ <sup>b</sup>	7.9	A	
	Continuous drain current @ $T_c=125^\circ\text{C}$ <sup>b</sup>	3.5		
$I_{DM}$	Pulse drain current (pulse width: 100 $\mu\text{s}$ )	14	A	
$P_D$	Maximum power dissipation @ $T_c=25^\circ\text{C}$	32	W	
$T_c$	Operating temperature	Case	-55~150	$^\circ\text{C}$
$T_J$		Junction	-55~150	$^\circ\text{C}$
$T_S$	Storage temperature	-55~150	$^\circ\text{C}$	

a. In off-state, spike duty cycle  $D < 0.01$ , spike duration  $< 1\mu\text{s}$

b. For increased stability at high current operation

## Thermal Resistance

Symbol	Parameter	Limit value	Unit
$R_{\theta JC}$	Junction-to-case	3.9	°C /W

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## Electrical Parameters

T<sub>J</sub>=25°C unless otherwise stated

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
<b>Forward Device Characteristics</b>						
V <sub>(BL)DSS</sub>	Drain-source voltage	650	-	-	V	V <sub>GS</sub> = 0V
V <sub>GS(th)</sub>	Gate threshold voltage	-	4	-	V	V <sub>DS</sub> =1V, I <sub>DS</sub> =1mA
ΔV <sub>GS(th)</sub> /T <sub>J</sub>	Gate threshold voltage temperature coefficient	-	-7	-	mV/°C	
R <sub>DS(on)</sub>	Drain-source on-resistance	-	270	320	mΩ	V <sub>GS</sub> =10V, I <sub>D</sub> =1A, T <sub>J</sub> =25°C
		-	570	-		V <sub>GS</sub> =10V, I <sub>D</sub> =1A, T <sub>J</sub> =150°C
I <sub>DSS</sub>	Drain-to-source leakage current	-	-	10	μA	V <sub>DS</sub> =650V, V <sub>GS</sub> = 0V, T <sub>J</sub> =25°C
		-	-	100		V <sub>DS</sub> =650V, V <sub>GS</sub> = 0V, T <sub>J</sub> =150°C
I <sub>GSS</sub>	Gate-to-source forward leakage current	-	-	±100	nA	V <sub>GS</sub> =±20V
C <sub>ISS</sub>	Input capacitance	-	293	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =400V, f=1MHz
C <sub>OSS</sub>	Output capacitance	-	17	-		
C <sub>RSS</sub>	Reverse capacitance	-	3.74	-		
Q <sub>G</sub>	Total gate charge	-	7.9	-	nC	V <sub>DS</sub> =400V, V <sub>GS</sub> =0V to 10V, I <sub>D</sub> =1A
Q <sub>GS</sub>	Gate-source charge	-	2.31	-		
Q <sub>GD</sub>	Gate-drain charge	-	1.65	-		
Q <sub>OSS</sub>	Output charge	-	22.2	-	nC	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V to 400V, f=1MHz
t <sub>D(on)</sub>	Turn-on delay	-	3.2	-	ns	V <sub>DS</sub> =400V, V <sub>GS</sub> =0V to 10V, I <sub>D</sub> =2.1A, R <sub>G-on(ext)</sub> =6.8Ω, R <sub>G-off(ext)</sub> =2.2Ω, L=250μH
t <sub>R</sub>	Rise time	-	5.5	-		
t <sub>D(off)</sub>	Turn-off delay	-	7.4	-		
t <sub>F</sub>	Fall time	-	27	-		

## Electrical Parameters

T<sub>J</sub>=25°C unless otherwise stated

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
<b>Reverse Device Characteristics</b>						
V <sub>SD</sub>	Source-Drain reverse voltage	-	2.3	-	V	V <sub>GS</sub> =0V, I <sub>SD</sub> =5A
t <sub>RR</sub>	Reverse recovery time	-	14	-	ns	I <sub>F</sub> =10A, V <sub>DD</sub> =400V, dI <sub>F</sub> /dt=165A/μs
Q <sub>RR</sub>	Reverse recovery charge	-	6.5	-	nC	

## Typical Characteristics

$T_J=25^\circ\text{C}$  unless otherwise stated

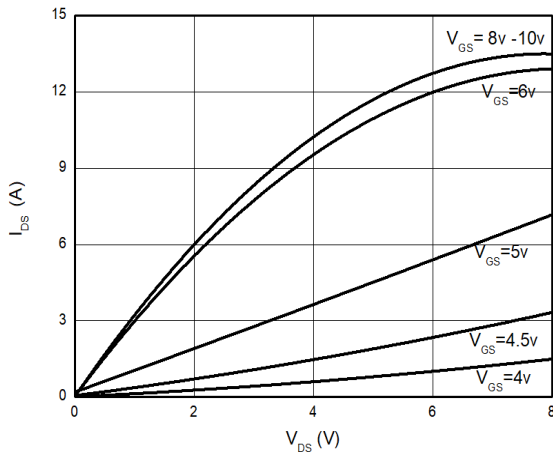


Figure 1. Typical Output Characteristics  $T_J=25^\circ\text{C}$

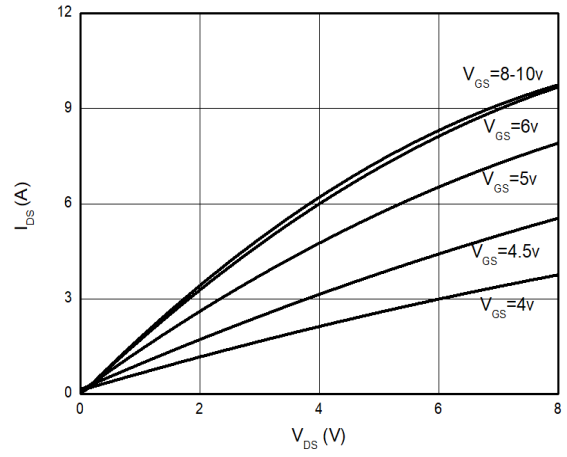


Figure 2. Typical Output Characteristics  $T_J=125^\circ\text{C}$

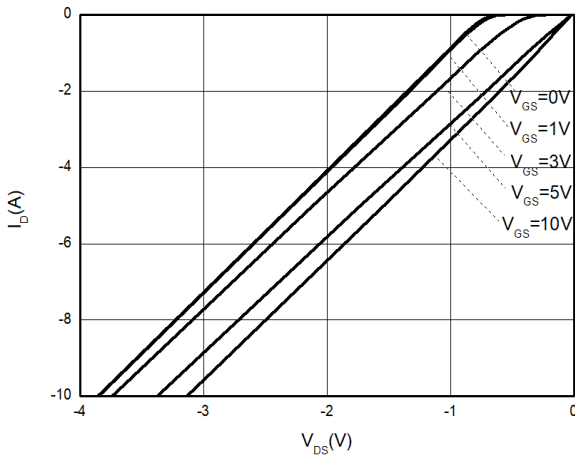


Figure 3. Channel Reverse Characteristics  $T_J=25^\circ\text{C}$

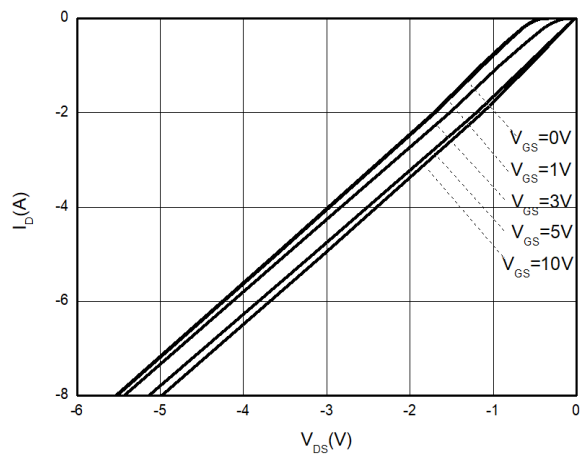


Figure 4. Channel Reverse Characteristics  $T_J=125^\circ\text{C}$

## Typical Characteristics

$T_J=25^\circ\text{C}$  unless otherwise stated

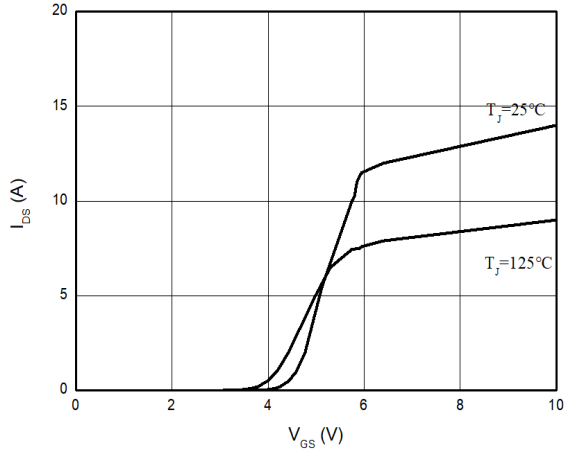


Figure 5. Typical Transfer Characteristics ( $V_{ds}=5V$ )

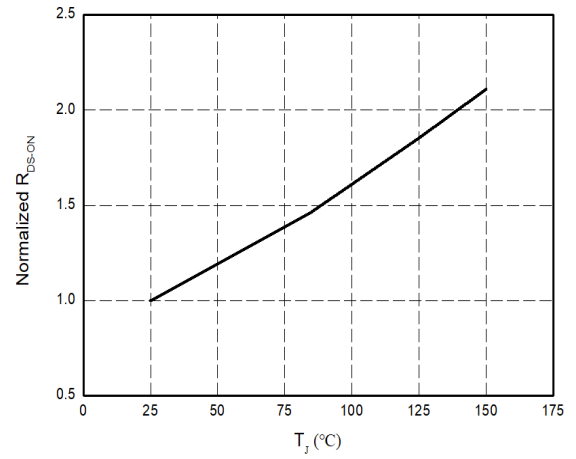


Figure 6. Normalized On-resistance

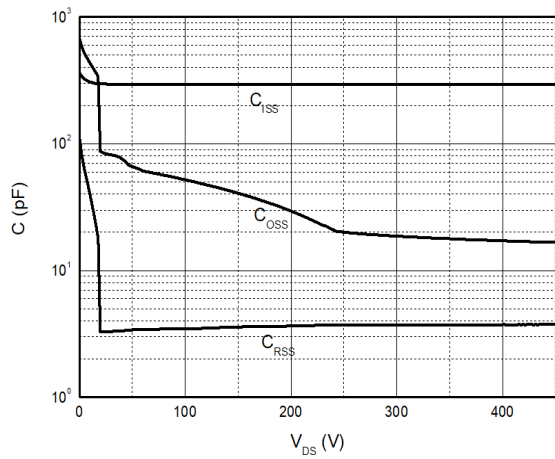


Figure 7. Typical Capacitance ( $f=1\text{MHz}$ )

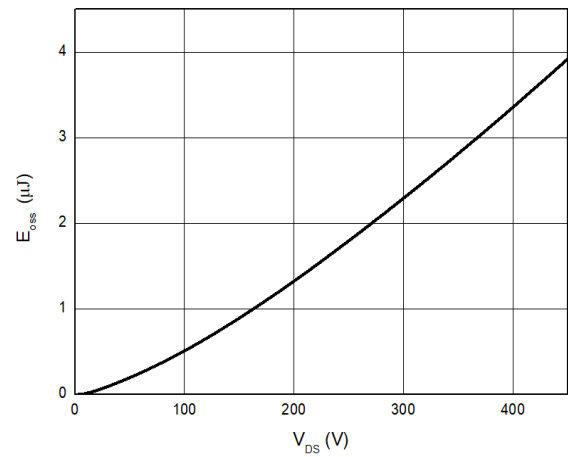


Figure 8. Typical  $C_{oss}$  Stored Energy

## Typical Characteristics

$T_J=25^\circ\text{C}$  unless otherwise stated

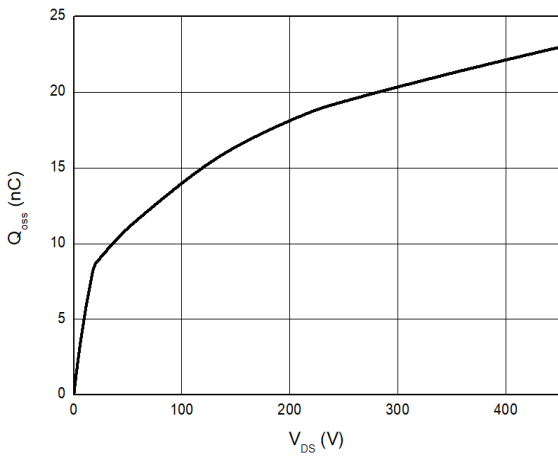


Figure 9. Typical  $Q_{oss}$

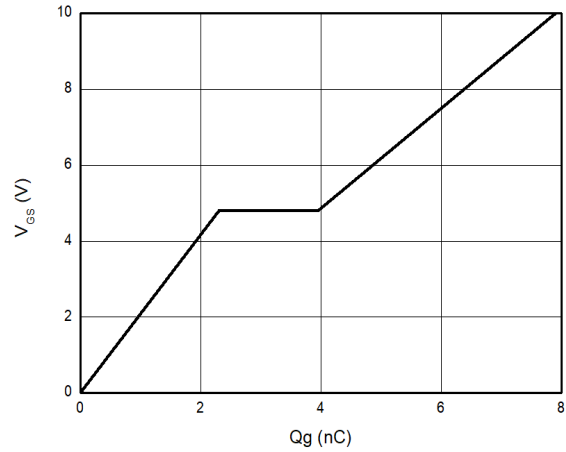


Figure 10. Typical Gate Charge ( $V_{DS}=400\text{V}$ ,  $I_D=1\text{A}$ )

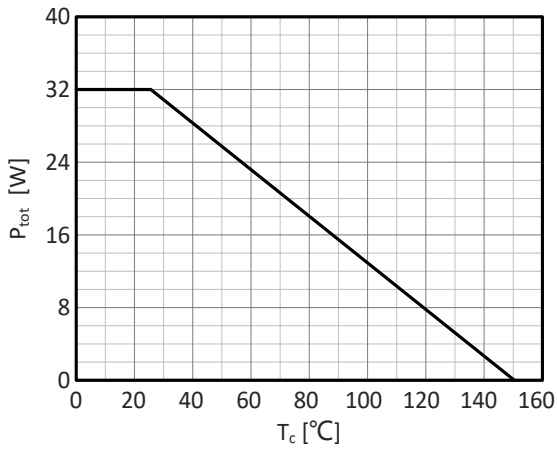


Figure 11. Power Dissipation

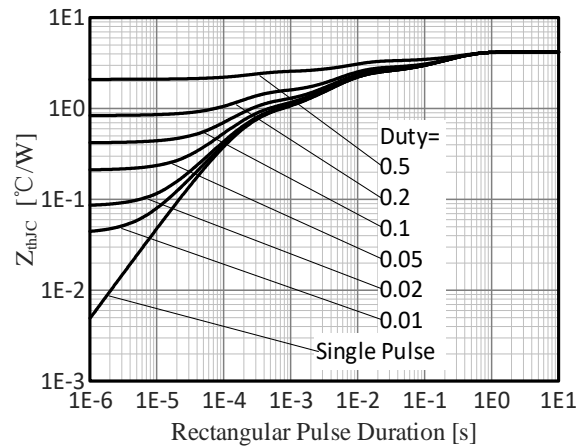


Figure 12. Transient Thermal Resistance



## Typical Characteristics

$T_J=25^\circ\text{C}$  unless otherwise stated

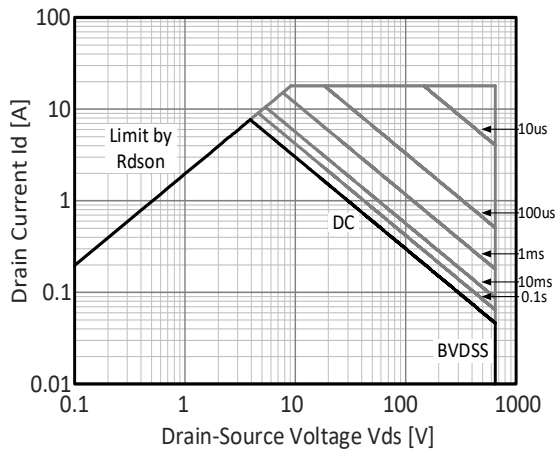


Figure 13. Safe Operating Area  $T_c=25^\circ\text{C}$

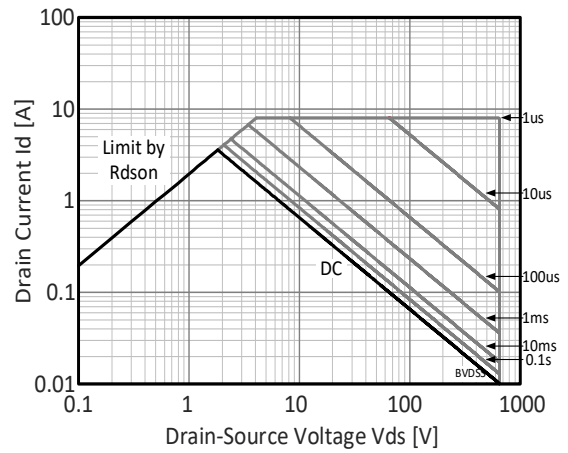


Figure 14. Safe Operating Area  $T_c=125^\circ\text{C}$

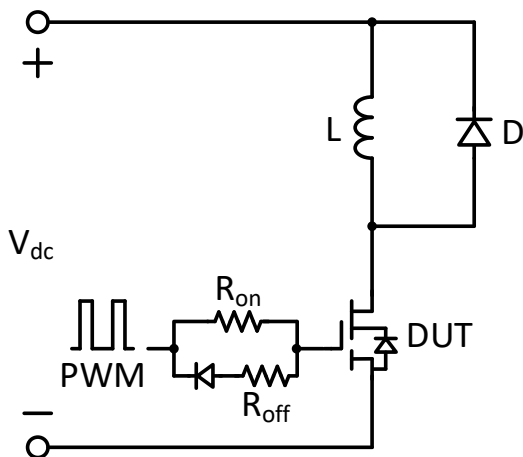


Figure 15. Switching times with inductive load

$V_{DS}=400\text{V}$ ,  $V_{GS}=0\text{V}$  to  $10\text{V}$ ,  $I_D=2.1\text{A}$ ,  
 $R_{G-on(ext)}=6.8\Omega$ ,  $R_{G-off(ext)}=2.2\Omega$ ,  $L=250\mu\text{H}$

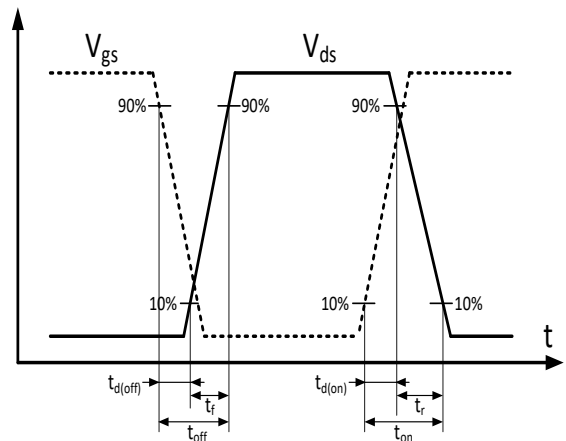
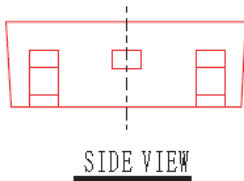
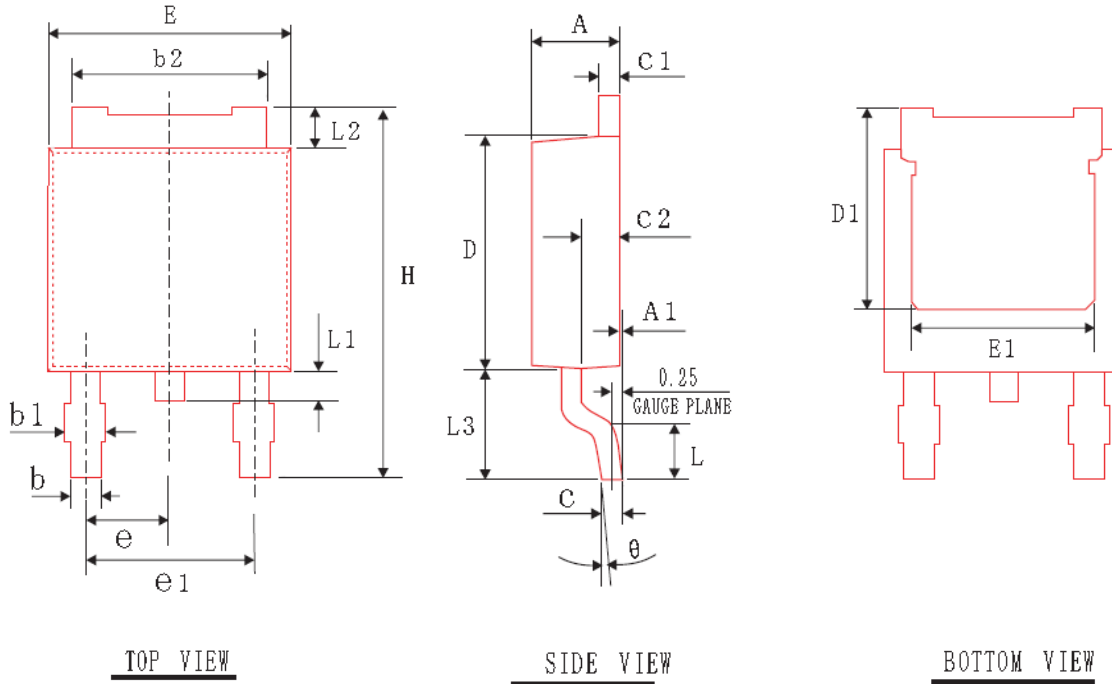


Figure 16. Switching times with waveform

## PACKAGE DIMENSIONS

TO252-2L



COMMON DIMENSIONS  
(UNITS OF MEASURE-mm)

SYMBOL	MIN	NOM	MAX
A	2.20	2.30	2.40
A1	0.00	0.05	0.10
b	0.762	0.812	0.862
b <sub>1</sub>	---	---	1.10
b <sub>2</sub>	5.23	5.33	5.43
c	0.458	0.508	0.558
c <sub>1</sub>	0.458	0.508	0.558
c <sub>2</sub>	0.80	1.00	1.20
D	6.00	6.10	6.20
D <sub>1</sub>	5.25	5.45	5.65
H	10.00	10.10	10.20
E	6.50	6.60	6.70
E <sub>1</sub>	4.75	4.85	4.95
e <sub>1</sub>	4.37	4.57	4.77
L	---	---	1.45
L <sub>1</sub>	0.60	0.75	0.90
L <sub>2</sub>	0.90	1.10	1.30
L <sub>3</sub>	2.80	3.00	3.20
$\theta$	0°	4°	8°
e	2.285 BSC		